

## APT10M11JVR

100V  $0.011\Omega$ 144A

# POWER MOS V®

Power MOS V® is a new generation of high voltage N-Channel enhancement mode power MOSFETs. This new technology minimizes the JFET effect, increases packing density and reduces the on-resistance. Power MOS V® also achieves faster switching speeds through optimized gate layout.



Faster Switching

100% Avalanche Tested

Lower Leakage

Popular SOT-227 Package



#### **MAXIMUM RATINGS**

All Ratings:  $T_C = 25^{\circ}C$  unless otherwise specified.

Symbol	Parameter	APT10M11JVR	UNIT	
V <sub>DSS</sub>	Drain-Source Voltage	100	Volts	
I <sub>D</sub>	Continuous Drain Current @ T <sub>C</sub> = 25°C	144	Amps	
I <sub>DM</sub>	Pulsed Drain Current ①	576		
V <sub>GS</sub>	Gate-Source Voltage Continuous	±30	Volts	
V <sub>GSM</sub>	Gate-Source Voltage Transient	±40		
P <sub>D</sub>	Total Power Dissipation @ T <sub>C</sub> = 25°C	450	Watts	
' D	Linear Derating Factor	3.6	W/°C	
T <sub>J</sub> ,T <sub>STG</sub>	Operating and Storage Junction Temperature Range	-55 to 150	°C	
T <sub>L</sub>	Lead Temperature: 0.063" from Case for 10 Sec.	300		
I <sub>AR</sub>	Avalanche Current (1) (Repetitive and Non-Repetitive)	144	Amps	
E <sub>AR</sub>	Repetitive Avalanche Energy <sup>①</sup>	50	mı	
E <sub>AS</sub>	Single Pulse Avalanche Energy <sup>4</sup>	2500	mJ	

#### STATIC ELECTRICAL CHARACTERISTICS

Avenue J.F. Kennedy Bât B4 Parc Cadéra Nord

Symbol	Characteristic / Test Conditions	MIN	TYP	MAX	UNIT
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage $(V_{GS} = 0V, I_D = 250\mu\text{A})$	100			Volts
I <sub>D(on)</sub>	On State Drain Current ② $(V_{DS} > I_{D(on)} \times R_{DS(on)} Max, V_{GS} = 10V)$	144			Amps
R <sub>DS(on)</sub>	Drain-Source On-State Resistance ② (V <sub>GS</sub> = 10V, 0.5 I <sub>D[Cont.]</sub> )			0.011	Ohms
I <sub>DSS</sub>	Zero Gate Voltage Drain Current $(V_{DS} = V_{DSS}, V_{GS} = 0V)$			250	μА
	Zero Gate Voltage Drain Current ( $V_{DS} = 0.8 V_{DSS}$ , $V_{GS} = 0V$ , $T_{C} = 125$ °C)			1000	
I <sub>GSS</sub>	Gate-Source Leakage Current $(V_{GS} = \pm 30V, V_{DS} = 0V)$			±100	nA
V <sub>GS(th)</sub>	Gate Threshold Voltage $(V_{DS} = V_{GS}, I_{D} = 2.5 \text{mA})$	2		4	Volts

CAUTION: These Devices are Sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

APT Website - http://www.advancedpower.com

405 S.W. Columbia Street Bend, Oregon 97702-1035 Phone: (541) 382-8028 FAX: (541) 388-0364 **EUROPE** F-33700 Merignac - France

Phone: (33) 5 57 92 15 15

FAX: (33) 5 56 47 97 61

Symbol	Characteristic	Test Conditions	MIN	TYP	MAX	UNIT
C <sub>iss</sub>	Input Capacitance	V <sub>GS</sub> = 0V		8600	10300	
C <sub>oss</sub>	Output Capacitance	V <sub>DS</sub> = 25V		3200	4480	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	f = 1 MHz		1180	1770	
$Q_g$	Total Gate Charge <sup>③</sup>	V <sub>GS</sub> = 10V		300	450	
Q <sub>gs</sub>	Gate-Source Charge	$V_{DD} = 0.5 V_{DSS}$		95	145	nC
$Q_{gd}$	Gate-Drain ("Miller") Charge	I <sub>D</sub> = 50A @ 25°C		110	165	
t <sub>d(on)</sub>	Turn-on Delay Time	V <sub>GS</sub> = 15V		16	32	
t <sub>r</sub>	Rise Time	$V_{DD} = 0.5 V_{DSS}$		48	96	20
t <sub>d(off)</sub>	Turn-off Delay Time	$I_{D} = I_{D[Cont.]} @ 25^{\circ}C$		51	75	ns
t <sub>f</sub>	Fall Time	$R_G = 0.6\Omega$		9	18	

#### SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS

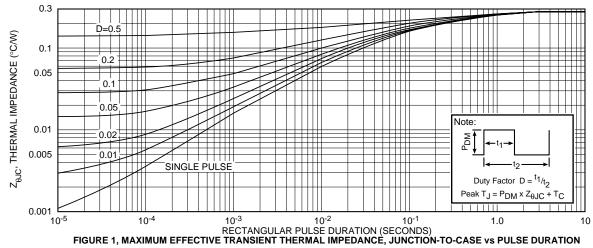
Symbol	Characteristic / Test Conditions	MIN	TYP	MAX	UNIT
I <sub>s</sub>	Continuous Source Current (Body Diode)			144	Amna
I <sub>SM</sub>	Pulsed Source Current (1) (Body Diode)			576	Amps
V <sub>SD</sub>	Diode Forward Voltage ② $(V_{GS} = 0V, I_{S} = -I_{D[Cont.]})$			1.3	Volts
t rr	Reverse Recovery Time $(I_S = -I_{D[Cont.]}, dI_S/dt = 100A/\mu s)$		250		ns
Q rr	Reverse Recovery Charge $(I_S = -I_{D[Cont.]}, dI_S/dt = 100A/\mu s)$		2.5		μС

### THERMAL/PACKAGE CHARACTERISTICS

Symbol	Characteristic	MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to Case			0.28	°C/W
$R_{\theta JA}$	Junction to Ambient			40	°C/W
V <sub>Isolation</sub>	RMS Voltage (50-60 Hz Sinusoidal Waveform From Terminals to Mounting Base for 1 Min.)	2500			Volts
Torque	Maximum Torque for Device Mounting Screws and Electrical Terminations.			13	lb•in

<sup>1</sup> Repetitive Rating: Pulse width limited by maximum junction temperature.

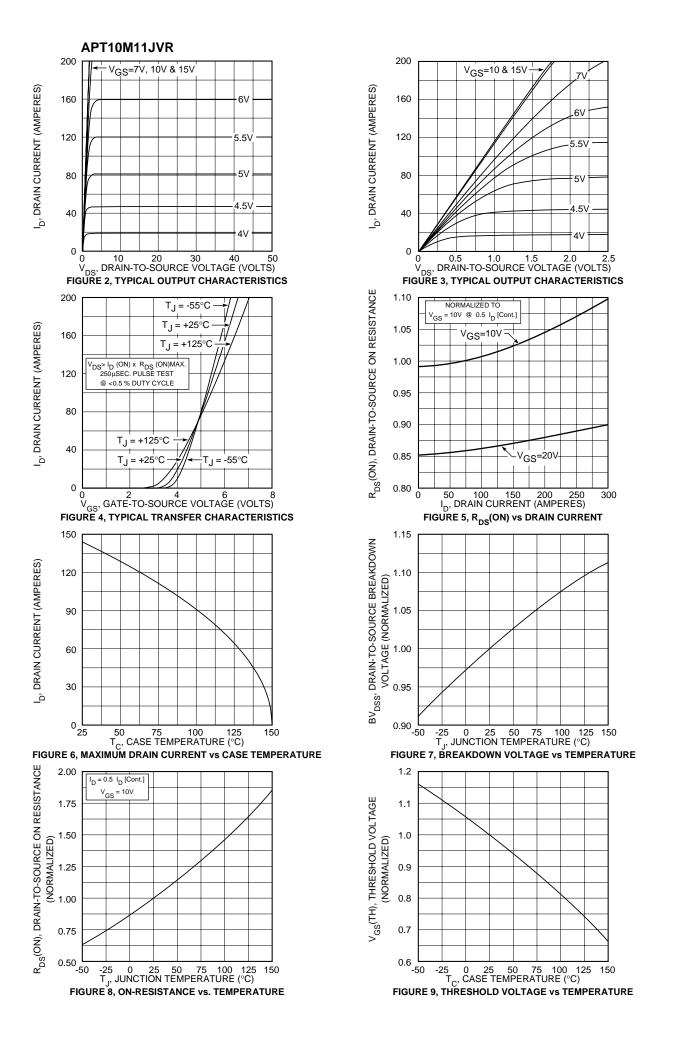
APT Reserves the right to change, without notice, the specifications and information contained herein.

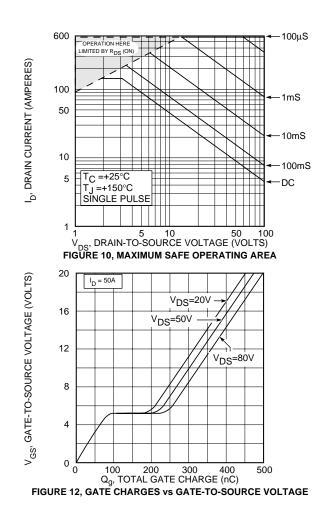


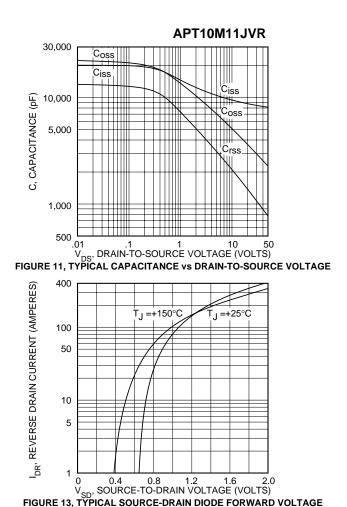
③ See MIL-STD-750 Method 3471

<sup>4</sup> Starting  $T_i = +25$ °C,  $L = 241\mu H$ ,  $R_G = 25\Omega$ , Peak  $I_L = 144A$ 

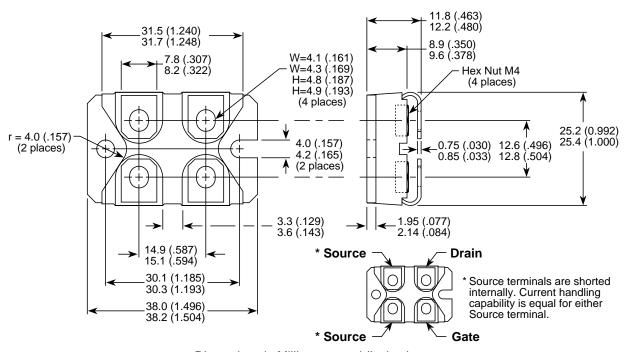
 $<sup>^{\</sup>circ}$  Pulse Test: Pulse width < 380  $\mu$ S, Duty Cycle < 2%







#### SOT-227 (ISOTOP®) Package Outline



Dimensions in Millimeters and (Inches)

4.748.103

5.283.202

5.231.474

5.434.095

5.528.058

"UL Recognized" File No. E145592

5.256.583